

CY7C281A

Selection Guide

		7C281A-25	7C281A-30	Unit
Maximum Access Time		25	30	ns
Maximum Operating Current	Commercial	100	100	mA

Maximum Ratings^[1]

(Above which the useful life may be impaired. For user guide- lines, not tested.)	
Storage Temperature65°C to +150°C	
Ambient Temperature with Power Applied55°C to +125°C	
Supply Voltage to Ground Potential (Pin 24 to Pin 12)0.5V to +7.0V	
DC Voltage Applied to Outputs in High Z State–0.5V to +7.0V	
DC Input Voltage3.0V to +7.0V	

DC Program Voltage (Pins 18, 20)	13.0V
Static Discharge Voltage (per MIL-STD-883, Method 3015)	>2001V
Latch-Up Current	>200 mA

Operating Range

Range	Ambient Temperature	v _{cc}
Commercial	0°C to +70°C	5V ±10%

Electrical Characteristics Over the Operating Range^[2,3]

				7C28	1A-25	7C28	1A-30	
Parameter	Description	Test Condi	Min.	Max.	Min.	Max.	Unit	
V _{OH}	Output HIGH Voltage	$V_{CC} = Min., I_{OH} = -4$	4.0 mA	2.4		2.4		V
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 16	6.0 mA		0.4		0.4	V
V _{IH}	Input HIGH Level	Guaranteed Input Lo Voltage for All Input	2.0		2.0		V	
V _{IL}	Input LOW Level	Guaranteed Input Lo Voltage for All Input		0.8		0.8	V	
I _{IX}	Input Current	$GND \leq V_{IN} \leq V_{CC}$	-10	+10	-10	+10	μΑ	
I _{OZ}	Output Leakage Current	$GND \leq V_{OUT} \leq V_{CC}$ Output Disabled	-10	+10	-10	+10	μA	
I _{OS}	Output Short Circuit Current ^[4]	V _{CC} = Max., V _{OUT} = GND		-20	-90	-20	-90	mA
I _{CC}	Power Supply Current	V _{CC} = Max., I _{OUT} = 0 mA	Commercial		100		100	mA
V _{PP}	Program Voltage				13	12	13	V
V _{IHP}	Program HIGH Voltage			3.0		3.0		V
V _{ILP}	Program LOW Voltage				0.4		0.4	V
I _{PP}	Program Supply Current				50		50	mA

Capacitance^[3]

Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	$T_{A} = 25^{\circ}C$, f = 1 MHz,	10	pF
C _{OUT}	Output Capacitance	$V_{CC} = 5.0V$	10	pF

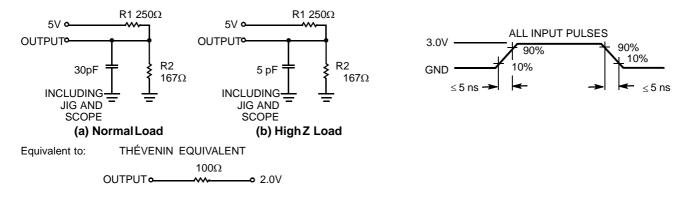
Notes

The voltage on any input or I/O pin cannot exceed the power pin during power-up.
See the last page of this specification for Group A subgroup testing information.
See "Introduction to CMOS PROMs" in this Data Book for general information on testing.
For test purposes, not more than one output at a time should be shorted. Short circuit test duration should not exceed 30 seconds.

Document #: 38-04003 Rev. *C



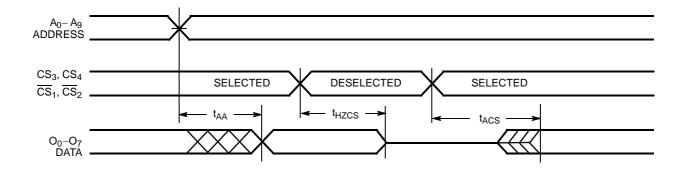
AC Test Loads and Waveforms^[3]



Switching Characteristics Over the Operating Range^[1,3]

		7C281A-25 7C281A-30		1A-30		
Parameter	Description	Min.	Max.	Min.	Max.	Unit
t _{AA}	Address to Output Valid		25		30	ns
t _{HZCS}	Chip Select Inactive to High Z		15		20	ns
t _{ACS}	Chip Select Active to Output Valid		15		20	ns

Switching Waveforms





Programming Information

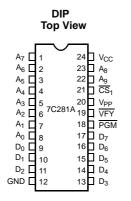
Programming support is available from Cypress as well as from a number of third party software vendors. For detailed

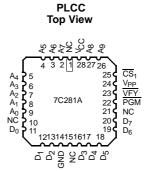
programming information, including a listing of software packages, please see the PROM Programming Information located at the end of this section. Programming algorithms can be obtained from any Cypress representative.

Table 1. Mode Selection

		Pin Function ^[5]					
	Read or Output Disable	A ₉ –A ₀	CS4	CS ₃	CS ₂	CS ₁	O ₇ –O ₀
Mode	Other	A ₉ –A ₀	PGM	VFY	V _{PP}	CS ₁	D7-D0
Read	·	A ₉ -A ₀	V _{IH}	V _{IH}	V _{IL}	V _{IL}	O ₇ –O ₀
Output Disa	ble	A ₉ -A ₀	Х	Х	V _{IH}	Х	High Z
Output Disa	ble	A ₉ -A ₀	Х	V _{IL}	Х	Х	High Z
Output Disa	ble	A ₉ -A ₀	V _{IL}	Х	Х	Х	High Z
Output Disa	ble	A ₉ -A ₀	Х	Х	Х	V _{IH}	High Z
Program		A ₉ -A ₀	V _{ILP}	V _{IHP}	V _{PP}	V _{ILP}	D ₇ -D ₀
Program Ve	rify	A ₉ -A ₀	V _{IHP}	V _{ILP}	V _{PP}	V _{ILP}	O ₇ O ₀
Program Inh	nibit	A ₉ -A ₀	V _{IHP}	V _{IHP}	V _{PP}	V _{ILP}	High Z
Intelligent Program		A ₉ -A ₀	V _{ILP}	V _{IHP}	V _{PP}	V _{ILP}	D ₇ -D ₀
Blank Check	<	A ₉ -A ₀	V _{IHP}	V _{ILP}	V _{PP}	V _{ILP}	Zeros

Figure 1. Programming Pinouts





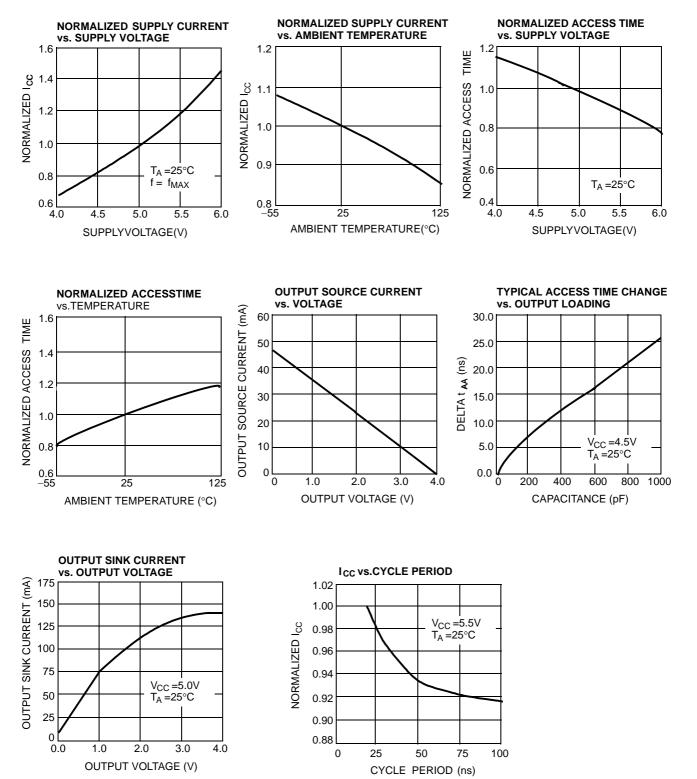
Note 5. X = "don't care" but not to exceed V_{CC} \pm 5%.

Document #: 38-04003 Rev. *C

Page 4 of 8



Typical DC and AC Characteristics



Document #: 38-04003 Rev. *C

Page 5 of 8

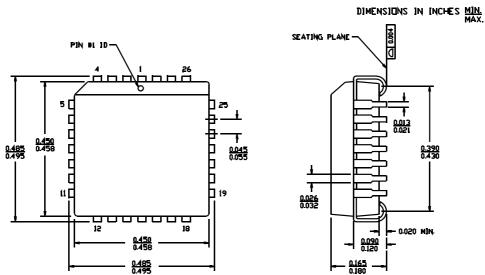


Ordering Information

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
25	CY7C281A-25JC	J64	28-Lead Plastic Leaded Chip Carrier	Commercial
30	CY7C281A-30PC	P13	24-Lead (300-Mil) Molded DIP	Commercial

Package Diagrams

Figure 2. 28-Lead Plastic Leaded Chip Carrier J64

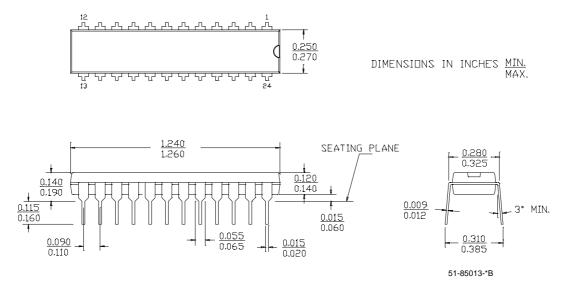


51-85001-*A



Package Diagrams

Figure 3. 24-Lead (300-Mil) PDIP P13



All product and company names mentioned in this document may be the trademarks of their respective holders.

Document #: 38-04003 Rev. *C

© Cypress Semiconductor Corporation, 2006. The information contained herein is subject to change without notice. Cypress Semiconductor Corporation assumes no responsibility for the use of any circuitry other than circuitry embodied in a Cypress product. Nor does it convey or imply any license under patent or other rights. Cypress products are not warranted nor intended to be used for medical, life support, life saving, critical control or safety applications, unless pursuant to an express written agreement with Cypress. Furthermore, Cypress does not authorize its products for use as critical components in life-support systems where a malfunction or failure may reasonably be expected to result in significant injury to the user. The inclusion of Cypress products in life-support systems application implies that the manufacturer assumes all risk of such use and in doing so indemnifies Cypress against all charges.



Document History Page

	Document Title: CY7C281A 1K x 8 PROM Document Number: 38-04003									
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change						
**	113859	03/06/02	DSG	Changed from Spec number: 38-00227 to 38-04003						
*A	118902	10/09/02	GBI	Updated ordering information						
*В	122244	12/27/02	RBI	Added power up requirements to Maximum ratings information						
*C	499538	See ECN	PCI	Updated ordering information						